



# Standard Recovery Diodes (Hockey PUK Version), 1200 A



DO-200AB (B-PUK)

### FEATURES

- Wide current range
- High voltage ratings up to 4500 V
- High surge current capabilities
- Diffused junction
- Hockey PUK version
- Case style DO-200AB (B-PUK)
- Material categorization: For definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



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### TYPICAL APPLICATIONS

- Converters
- Power supplies
- Machine tool controls
- High power drives
- Medium traction applications

PRODUCT SUMMARY	
$I_{F(AV)}$	1200 A
Package	DO-200AB (B-PUK)
Circuit configuration	Single diode

MAJOR RATINGS AND CHARACTERISTICS				
PARAMETER	TEST CONDITIONS	SD800C..L		UNITS
		24 to 36	40 to 45	
$I_{F(AV)}$		1180	1065	A
	$T_{hs}$	55	55	°C
$I_{F(RMS)}$		2280	2040	A
	$T_{hs}$	25	25	°C
$I_{FSM}$	50 Hz	13 600	12 200	A
	60 Hz	14 240	12 800	
$I^2t$	50 Hz	925	745	kA <sup>2</sup> s
	60 Hz	845	680	
$V_{RRM}$	Range	2400 to 3600	4000 to 4500	V
$T_J$		-40 to 150	-40 to 150	°C

### ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS				
TYPE NUMBER	VOLTAGE CODE	$V_{RRM}$ , MAXIMUM REPETITIVE PEAK REVERSE VOLTAGE V	$V_{RSM}$ , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	$I_{RRM}$ MAXIMUM AT $T_J = T_J$ MAXIMUM mA
VS-SD800C..L	24	2400	2500	50
	30	3000	3100	
	36	3600	3700	
	40	4000	4100	
	45	4500	4600	



FORWARD CONDUCTION							
PARAMETER	SYMBOL	TEST CONDITIONS		SD800C..L		UNITS	
				24 to 36	40 to 45		
Maximum average forward current at heatsink temperature	$I_{F(AV)}$	180° conduction, half sine wave Double side (single side) cooled		1180 (550)	1065 (490)	A	
				55 (85)	55 (85)	°C	
Maximum RMS forward current	$I_{F(RMS)}$	25 °C heatsink temperature double side cooled		2280	2040		
Maximum peak, one-cycle forward, non-repetitive surge current	$I_{FSM}$	t = 10 ms	No voltage reappplied	Sinusoidal half wave, initial $T_J = T_J$ maximum	13 600	12 200	A
		t = 8.3 ms			14 240	12 800	
		t = 10 ms	50 % $V_{RRM}$ reappplied		11 440	10 250	
		t = 8.3 ms			11 980	10 750	
Maximum $I^2t$ for fusing	$I^2t$	t = 10 ms	No voltage reappplied		925	745	kA <sup>2</sup> s
		t = 8.3 ms			845	680	
		t = 10 ms	50 % $V_{RRM}$ reappplied		654	526	
		t = 8.3 ms			597	480	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	t = 0.1 to 10 ms, no voltage reappplied		9250	7450	kA <sup>2</sup> √s	
Low level value of threshold voltage	$V_{F(TO)1}$	$(16.7 \% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$ , $T_J = T_J$ maximum		0.90	1.06	V	
High level value of threshold voltage	$V_{F(TO)2}$	$(I > \pi \times I_{F(AV)})$ , $T_J = T_J$ maximum		1.10	1.18		
Low level value of forward slope resistance	$r_{f1}$	$(16.7 \% \times \pi \times I_{F(AV)} < I < \pi \times I_{F(AV)})$ , $T_J = T_J$ maximum		0.38	0.44	mΩ	
High level value of forward slope resistance	$r_{f2}$	$(I > \pi \times I_{F(AV)})$ , $T_J = T_J$ maximum		0.34	0.41		
Maximum forward voltage drop	$V_{FM}$	$I_{pk} = 2000$ A, $T_J = T_J$ maximum, $t_p = 10$ ms sinusoidal wave		1.66	1.95	V	

THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction operating temperature range	$T_J$		- 40 to 150	°C
Maximum storage temperature range	$T_{Stg}$		- 55 to 200	
Maximum thermal resistance, junction to heatsink	$R_{thJ-hs}$	DC operation single side cooled	0.073	K/W
		DC operation double side cooled	0.031	
Mounting force, ± 10 %			14 700 (1500)	N (kg)
Approximate weight			255	g
Case style		See dimensions - link at the end of datasheet	DO-200AB (B-PUK)	

$\Delta R_{thJ-hs}$ CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		RECTANGULAR CONDUCTION		TEST CONDITIONS	UNITS
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE		
180°	0.009	0.009	0.006	0.006	$T_J = T_J$ maximum	K/W
120°	0.011	0.011	0.011	0.011		
90°	0.014	0.014	0.015	0.015		
60°	0.020	0.020	0.021	0.021		
30°	0.036	0.036	0.036	0.036		

**Note**

- The table above shows the increment of thermal resistance  $R_{thJ-hs}$  when devices operate at different conduction angles than DC

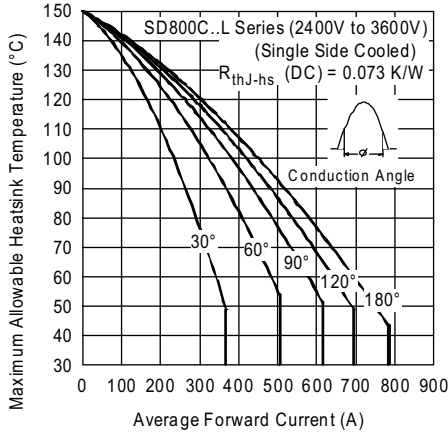


Fig. 1 - Current Ratings Characteristics

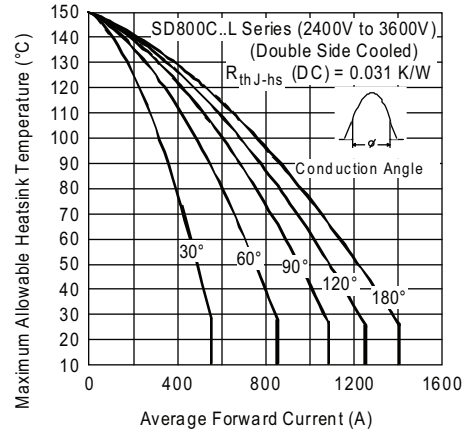


Fig. 4 - Current Ratings Characteristics

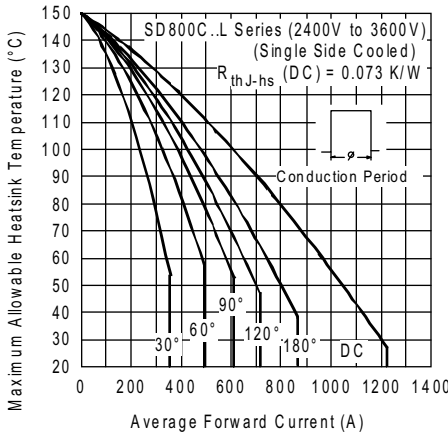


Fig. 2 - Current Ratings Characteristics

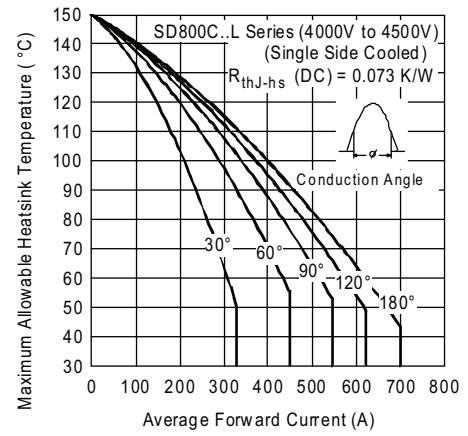


Fig. 5 - Current Ratings Characteristics

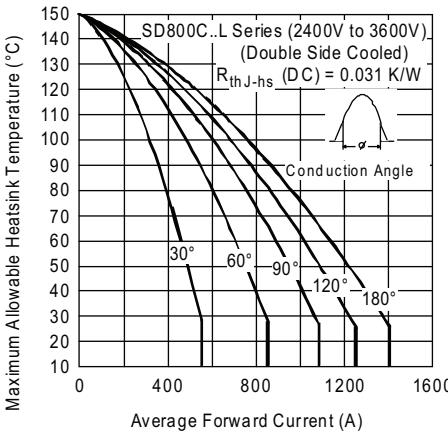


Fig. 3 - Current Ratings Characteristics

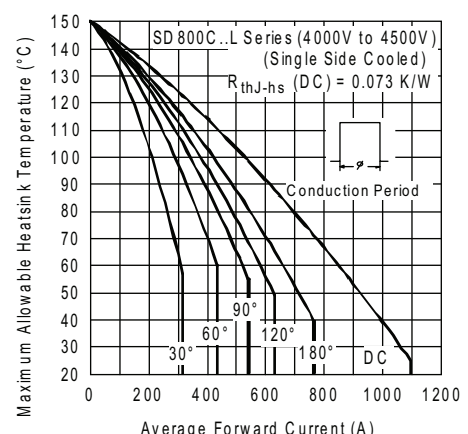


Fig. 6 - Current Ratings Characteristics

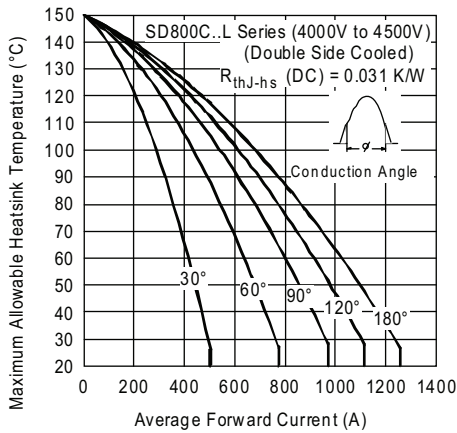


Fig. 7 - Current Ratings Characteristics

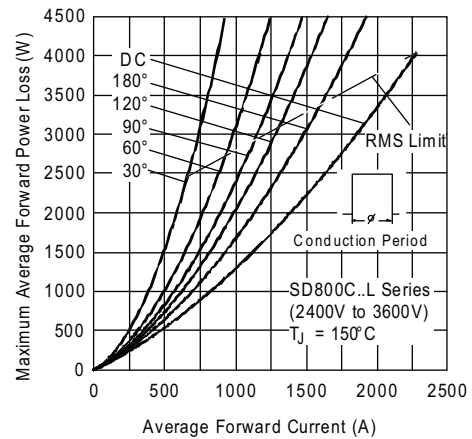


Fig. 10 - Forward Power Loss Characteristics

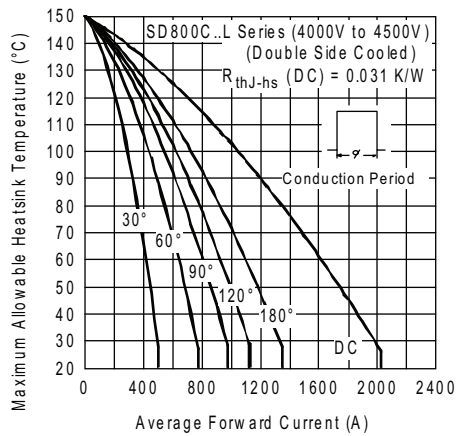


Fig. 8 - Current Ratings Characteristics

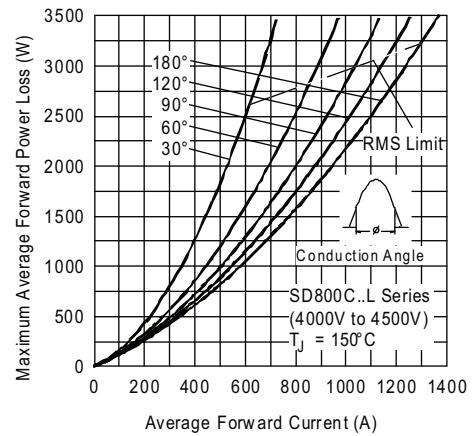


Fig. 11 - Forward Power Loss Characteristics

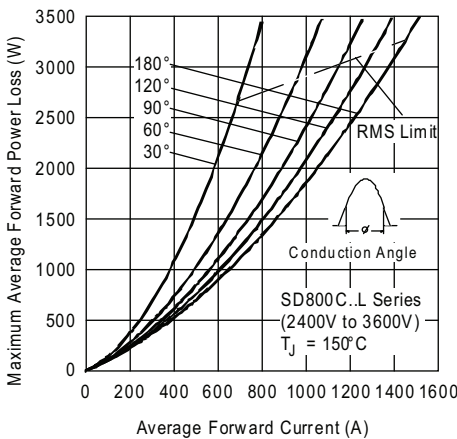


Fig. 9 - Forward Power Loss Characteristics

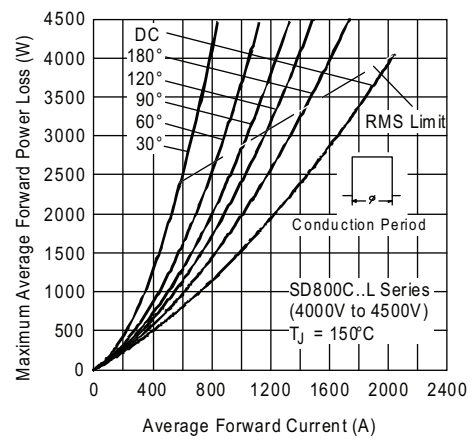


Fig. 12 - Forward Power Loss Characteristics

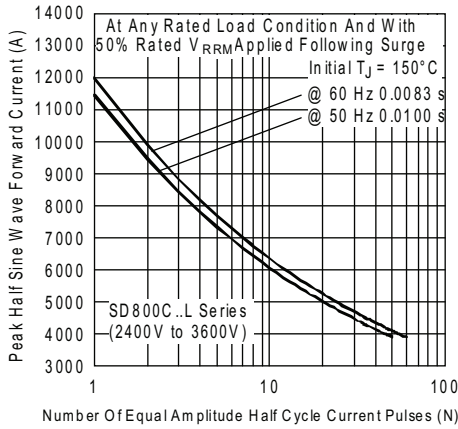


Fig. 13 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

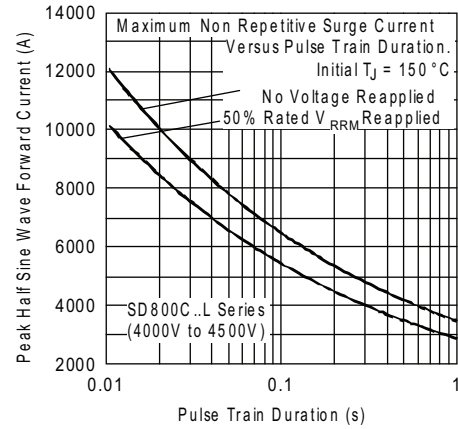


Fig. 16 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

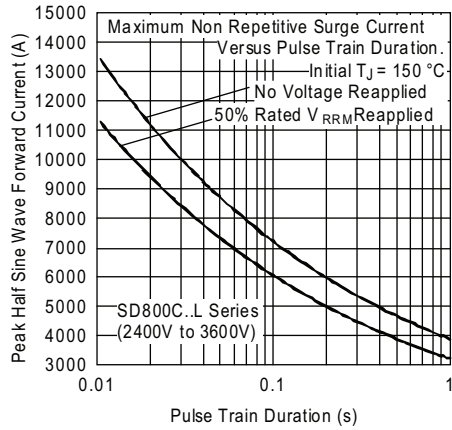


Fig. 14 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

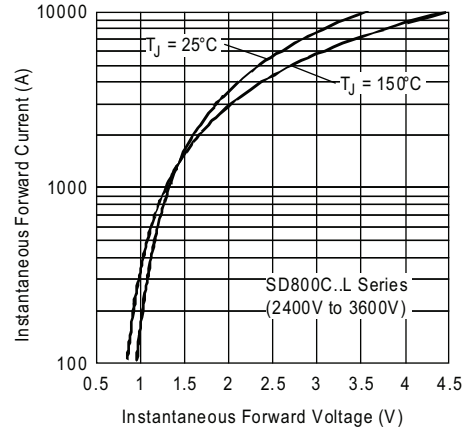


Fig. 17 - Forward Voltage Drop Characteristics

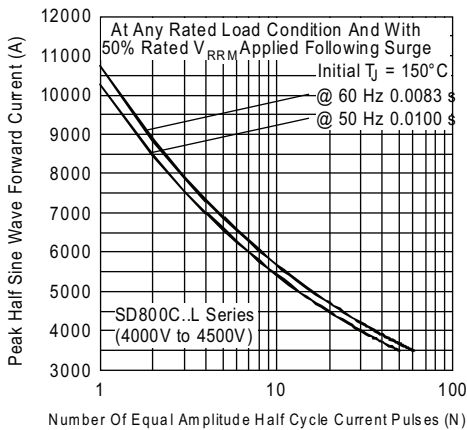


Fig. 15 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

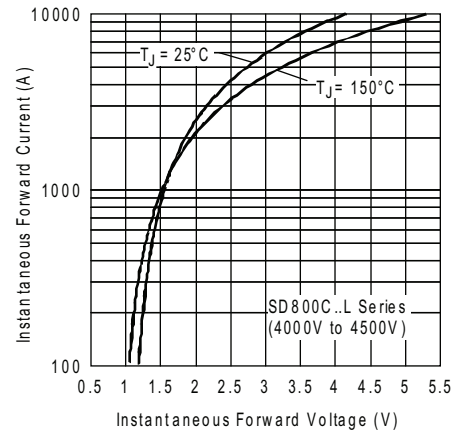


Fig. 18 - Forward Voltage Drop Characteristics

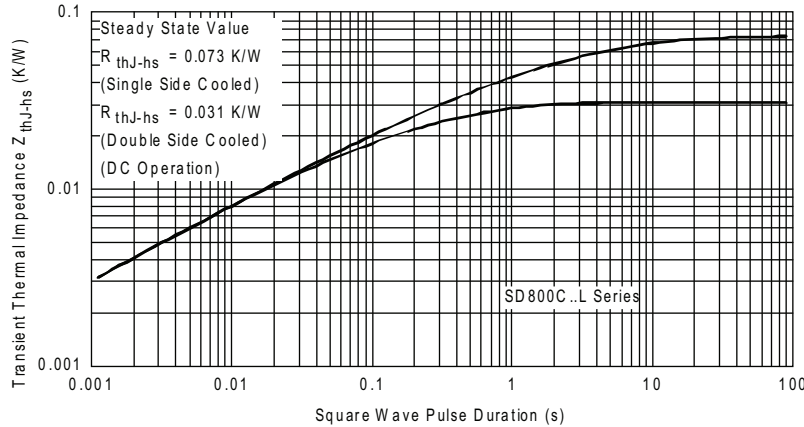


Fig. 19 - Thermal Impedance  $Z_{thJ-hs}$  Characteristics

**ORDERING INFORMATION TABLE**

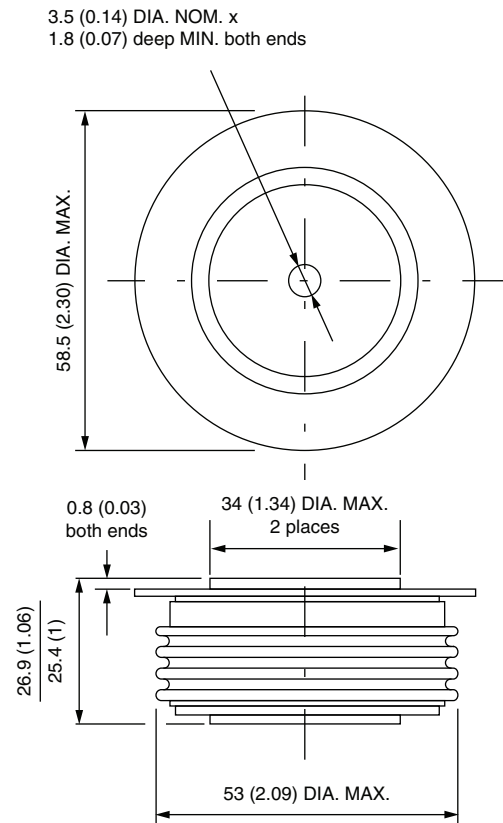
Device code	<b>VS-</b>	<b>SD</b>	<b>80</b>	<b>0</b>	<b>C</b>	<b>45</b>	<b>L</b>
	①	②	③	④	⑤	⑥	

- 1** - Vishay Semiconductors product
- 2** - Diode
- 3** - Essential part number
- 4** - 0 = Standard recovery
- 5** - C = Ceramic PUK
- 6** - Voltage code x 100 =  $V_{RRM}$  (see Voltage Ratings table)
- 6** - L = PUK case DO-200AB (B-PUK)

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95246">www.vishay.com/doc?95246</a>

## DO-200AB (B-PUK)

**DIMENSIONS** in millimeters (inches)



Quote between upper and lower pole pieces has to be considered after application of mounting force (see Thermal and Mechanical Specifications)



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### Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: [info@moschip.ru](mailto:info@moschip.ru)

Skype отдела продаж:

moschip.ru

moschip.ru\_4

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